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Name of control Toshiaki KAV Hideo ISHIKA Masaaki SAK	AWA B JAN	102341755 2. Name and Address of receiving party(ies) Name: DAIDO METAL CO., LTD. Address: 13F, Nagoya Hirokoji Bldg 3-1, Sakae 2-chome, Naka-ku, Nago JAPAN	ya
Additional name(s) of	conveying party(ies) attached? [] Yes [XX] f	Additional name(s) & address(es) attached? [] Ye	s [XX]
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Execution Date: D	December 6, 2002		
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PATENT REEL: 013661 FRAME: 0187

ASSIGNMENT

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by DAIDO METAL COMPANY LTD., a corporation organized under the laws of Japan, located at 13F, Nagoya Hirokoji Bldg., 3-1, Sakae 2-chome, Naka-ku, Nagoya, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said DAIDO METAL COMPANY LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

"SLIDING MEMBER WITH COMPOSITE PLATING FILM"

RECORDED: 01/14/2003

*U.S. Serial No. 10/263,816 filed on October 4, 2002 and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said DAIDO METAL COMPANY LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said DAIDO METAL COMPANY LTD.

> PATENT REEL: 013661 FRAME: 0188